

STARPOWER

SEMICONDUCTOR

IGBT

GD900SGX120C2SA_B20

1200V/900A 1 in one-package

General Description

STARPOWER IGBT Power Module provides ultra low conduction loss as well as short circuit ruggedness. They are designed for the applications such as general inverters and UPS.

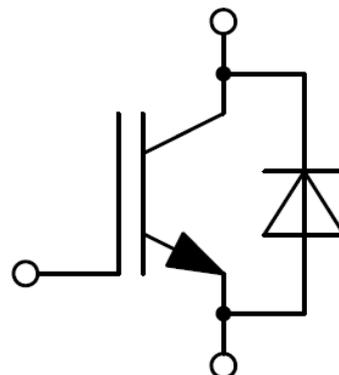
Features

- Low $V_{CE(sat)}$ Trench IGBT technology
- 10 μ s short circuit capability
- $V_{CE(sat)}$ with positive temperature coefficient
- Maximum junction temperature 175°C
- Low inductance case
- Fast & soft reverse recovery anti-parallel FWD
- Isolated copper baseplate using HPS DBC technology

Typical Applications

- Inverter for motor drive
- AC and DC servo drive amplifier
- Uninterruptible power supply

Equivalent Circuit Schematic



Absolute Maximum Ratings $T_C=25^{\circ}\text{C}$ unless otherwise noted**IGBT**

Symbol	Description	Value	Unit
V_{CES}	Collector-Emitter Voltage	1200	V
V_{GES}	Gate-Emitter Voltage	± 20	V
I_C	Collector Current @ $T_C=25^{\circ}\text{C}$ @ $T_C=100^{\circ}\text{C}$	1550 900	A
I_{CM}	Pulsed Collector Current $t_p=1\text{ms}$	1800	A
P_D	Maximum Power Dissipation @ $T_j=175^{\circ}\text{C}$	4838	W

Diode

Symbol	Description	Value	Unit
V_{RRM}	Repetitive Peak Reverse Voltage	1200	V
I_F	Diode Continuous Forward Current	900	A
I_{FM}	Diode Maximum Forward Current $t_p=1\text{ms}$	1800	A

Module

Symbol	Description	Value	Unit
T_{jmax}	Maximum Junction Temperature	175	$^{\circ}\text{C}$
T_{jop}	Operating Junction Temperature	-40 to +150	$^{\circ}\text{C}$
T_{STG}	Storage Temperature Range	-40 to +125	$^{\circ}\text{C}$
V_{ISO}	Isolation Voltage RMS, $f=50\text{Hz}$, $t=1\text{min}$	4000	V

IGBT Characteristics $T_c=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit	
$V_{CE(sat)}$	Collector to Emitter Saturation Voltage	$I_C=900\text{A}, V_{GE}=15\text{V}, T_j=25^\circ\text{C}$		1.65	2.00	V	
		$I_C=900\text{A}, V_{GE}=15\text{V}, T_j=125^\circ\text{C}$		1.90			
		$I_C=900\text{A}, V_{GE}=15\text{V}, T_j=150^\circ\text{C}$		2.00			
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$I_C=36.0\text{mA}, V_{CE}=V_{GE}, T_j=25^\circ\text{C}$	5.6	6.2	6.8	V	
I_{CES}	Collector Cut-Off Current	$V_{CE}=V_{CES}, V_{GE}=0\text{V}, T_j=25^\circ\text{C}$			1.0	mA	
I_{GES}	Gate-Emitter Leakage Current	$V_{GE}=V_{GES}, V_{CE}=0\text{V}, T_j=25^\circ\text{C}$			400	nA	
R_{Gint}	Internal Gate Resistance			0.25		Ω	
C_{ies}	Input Capacitance	$V_{CE}=25\text{V}, f=100\text{kHz}, V_{GE}=0\text{V}$		92.8		nF	
C_{res}	Reverse Transfer Capacitance			2.80		nF	
Q_G	Gate Charge	$V_{GE}=-15\dots+15\text{V}$		7.44		μC	
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=600\text{V}, I_C=900\text{A}, R_G=1.0\Omega, L_S=52\text{nH}, V_{GE}=\pm 15\text{V}, T_j=25^\circ\text{C}$		102		ns	
t_r	Rise Time			145		ns	
$t_{d(off)}$	Turn-Off Delay Time			521		ns	
t_f	Fall Time			197		ns	
E_{on}	Turn-On Switching Loss			25.1		mJ	
E_{off}	Turn-Off Switching Loss			105		mJ	
$t_{d(on)}$	Turn-On Delay Time		$V_{CC}=600\text{V}, I_C=900\text{A}, R_G=1.0\Omega, L_S=52\text{nH}, V_{GE}=\pm 15\text{V}, T_j=125^\circ\text{C}$		113		ns
t_r	Rise Time				165		ns
$t_{d(off)}$	Turn-Off Delay Time			558		ns	
t_f	Fall Time			316		ns	
E_{on}	Turn-On Switching Loss			35.4		mJ	
E_{off}	Turn-Off Switching Loss			124		mJ	
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=600\text{V}, I_C=900\text{A}, R_G=1.0\Omega, L_S=52\text{nH}, V_{GE}=\pm 15\text{V}, T_j=150^\circ\text{C}$			117		ns
t_r	Rise Time				172		ns
$t_{d(off)}$	Turn-Off Delay Time			561		ns	
t_f	Fall Time			341		ns	
E_{on}	Turn-On Switching Loss			37.0		mJ	
E_{off}	Turn-Off Switching Loss			130		mJ	
I_{SC}	SC Data		$t_p \leq 10\mu\text{s}, V_{GE}=15\text{V}, T_j=150^\circ\text{C}, V_{CC}=800\text{V}, V_{CEM} \leq 1200\text{V}$		3600		A

Diode Characteristics $T_C=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
V_F	Diode Forward Voltage	$I_F=900\text{A}, V_{GE}=0\text{V}, T_j=25^\circ\text{C}$		1.90	2.35	V
		$I_F=900\text{A}, V_{GE}=0\text{V}, T_j=125^\circ\text{C}$		2.00		
		$I_F=900\text{A}, V_{GE}=0\text{V}, T_j=150^\circ\text{C}$		2.05		
Q_r	Recovered Charge			35.5		μC
I_{RM}	Peak Reverse Recovery Current	$V_R=600\text{V}, I_F=900\text{A},$ $-di/dt=8700\text{A}/\mu\text{s}, V_{GE}=-15\text{V},$ $L_S=52\text{nH}, T_j=25^\circ\text{C}$		635		A
E_{rec}	Reverse Recovery Energy			31.2		mJ
Q_r	Recovered Charge			57.3		μC
I_{RM}	Peak Reverse Recovery Current	$V_R=600\text{V}, I_F=900\text{A},$ $-di/dt=8100\text{A}/\mu\text{s}, V_{GE}=-15\text{V},$ $L_S=52\text{nH}, T_j=125^\circ\text{C}$		715		A
E_{rec}	Reverse Recovery Energy			57.4		mJ
Q_r	Recovered Charge			70.1		μC
I_{RM}	Peak Reverse Recovery Current	$V_R=600\text{V}, I_F=900\text{A},$ $-di/dt=7900\text{A}/\mu\text{s}, V_{GE}=-15\text{V},$ $L_S=52\text{nH}, T_j=150^\circ\text{C}$		753		A
E_{rec}	Reverse Recovery Energy			67.4		mJ

Module Characteristics $T_C=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Min.	Typ.	Max.	Unit
L_{CE}	Stray Inductance			20	nH
$R_{CC'+EE'}$	Module Lead Resistance, Terminal to Chip		0.18		m Ω
R_{thJC}	Junction-to-Case (per IGBT)			0.031	K/W
	Junction-to-Case (per Diode)			0.058	
R_{thCH}	Case-to-Heatsink (per IGBT)		0.015		K/W
	Case-to-Heatsink (per Diode)		0.029		
	Case-to-Heatsink (per Module)		0.010		
M	Terminal Connection Torque, Screw M4	1.1		2.0	N.m
	Terminal Connection Torque, Screw M6	2.5		5.0	
	Mounting Torque, Screw M6	3.0		5.0	
G	Weight of Module		320		g

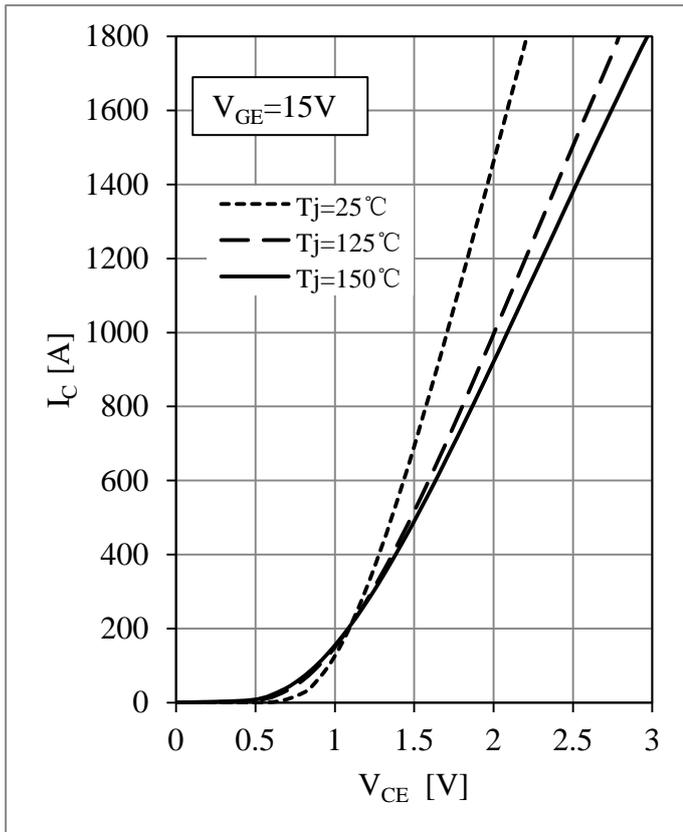


Fig 1. IGBT Output Characteristics

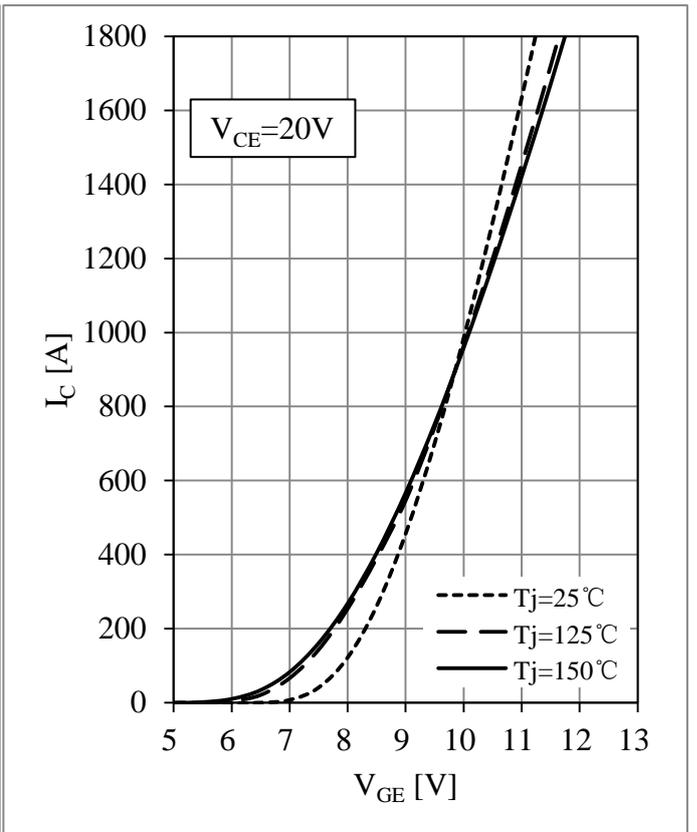


Fig 2. IGBT Transfer Characteristics

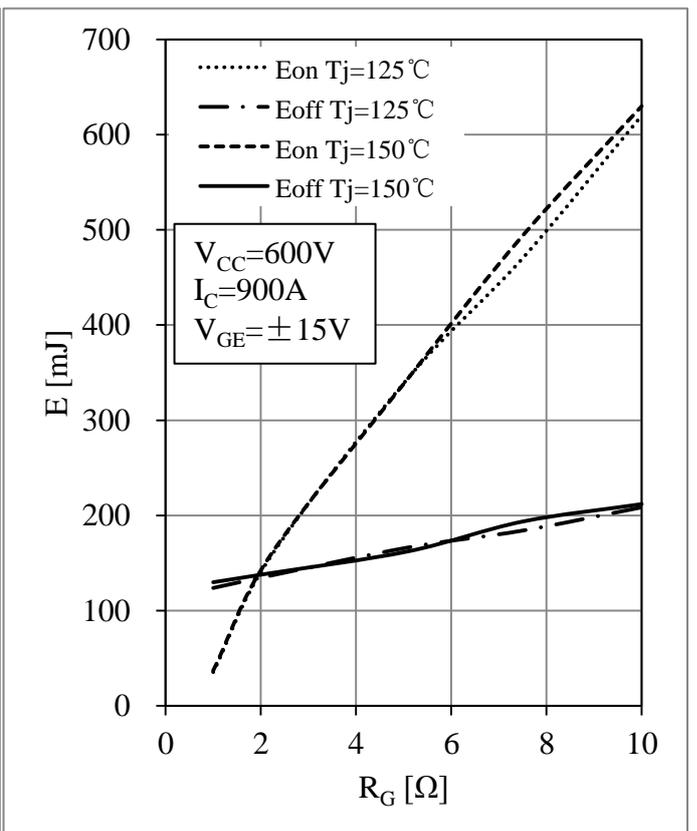
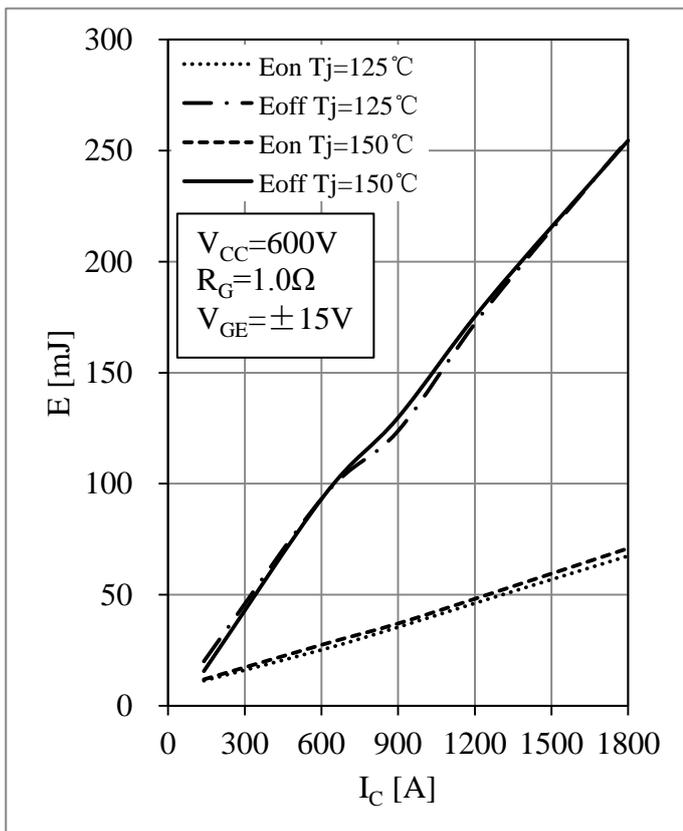


Fig 3. IGBT Switching Loss vs. I_C

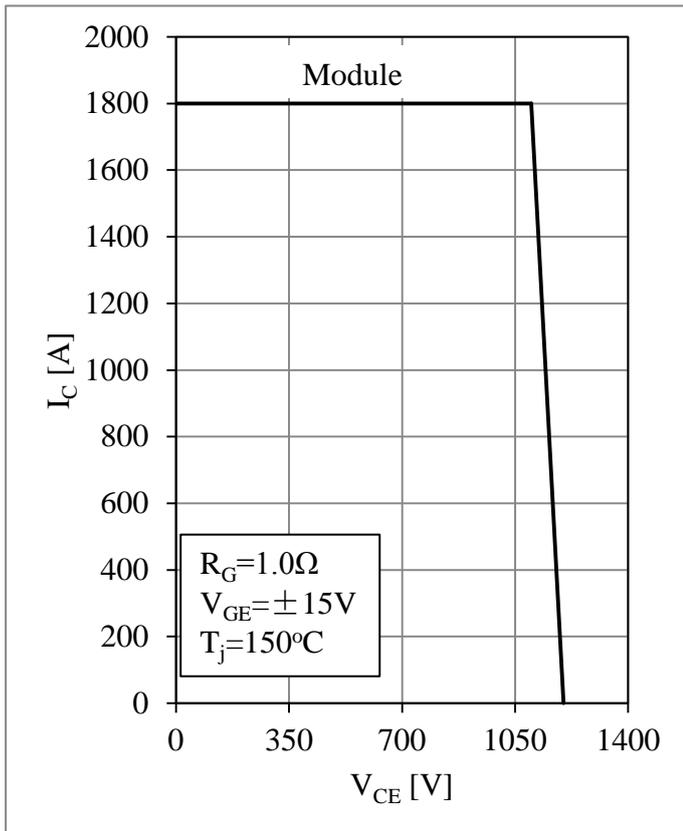


Fig 4. IGBT Switching Loss vs. R_G

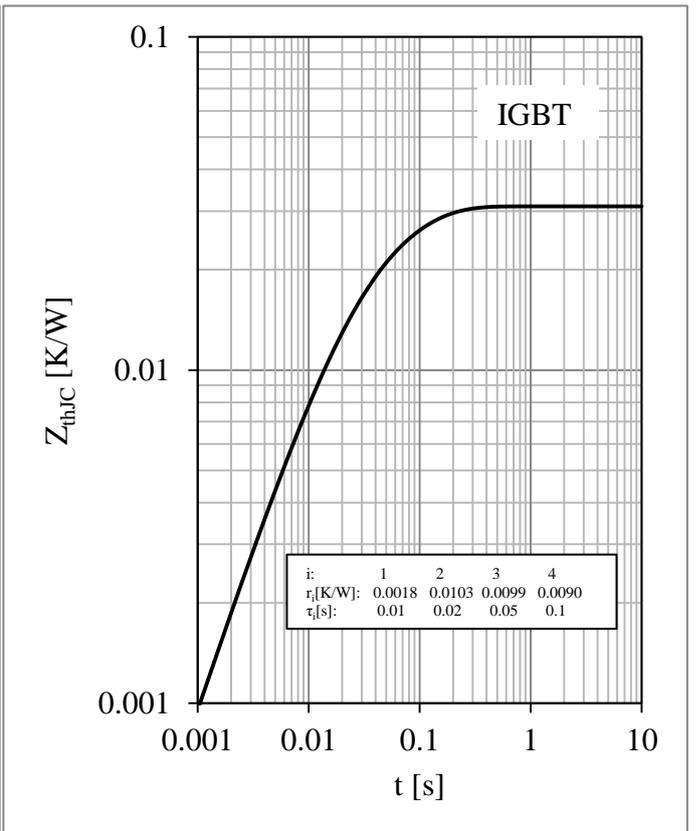


Fig 5. RBSOA

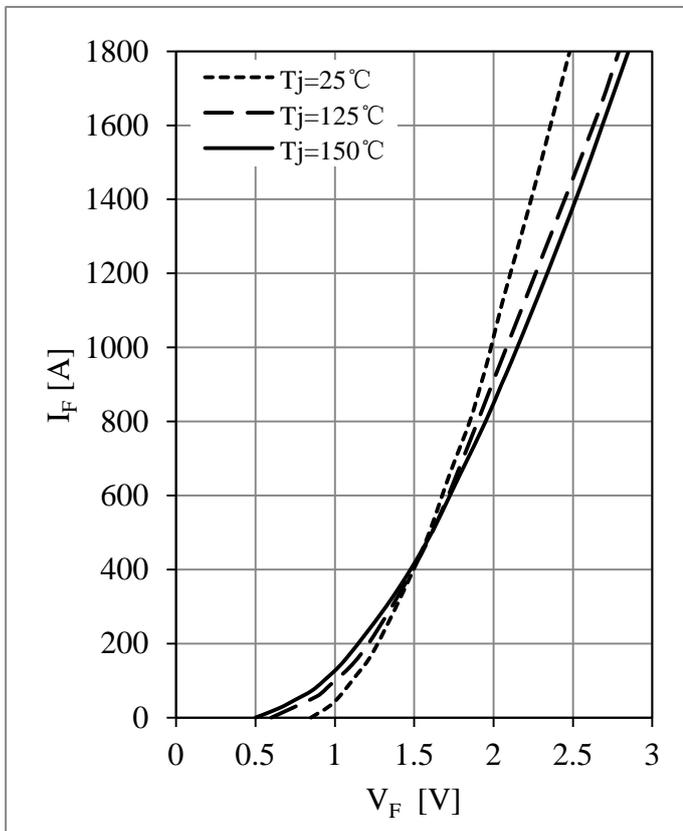


Fig 6. IGBT Transient Thermal Impedance

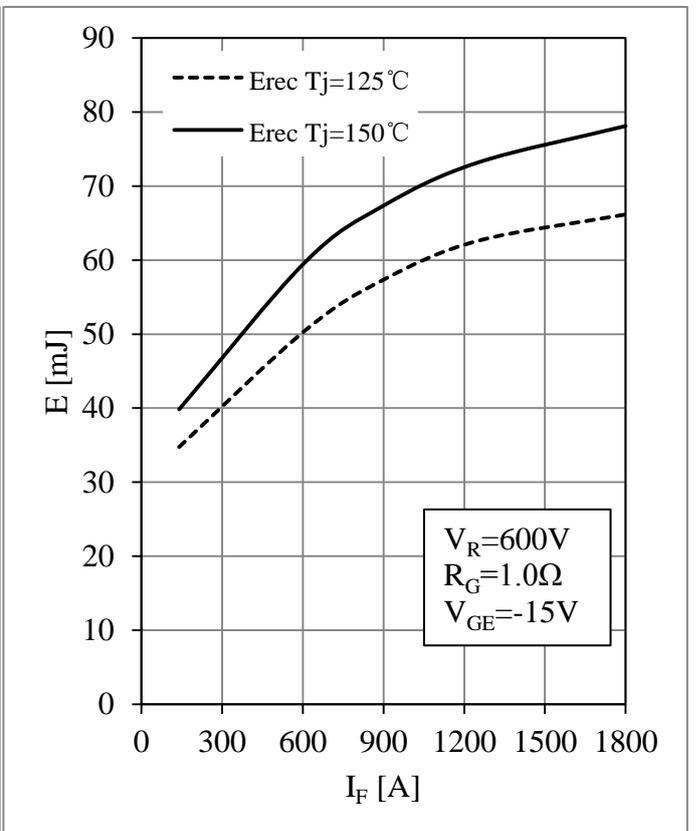


Fig 7. Diode Forward Characteristics

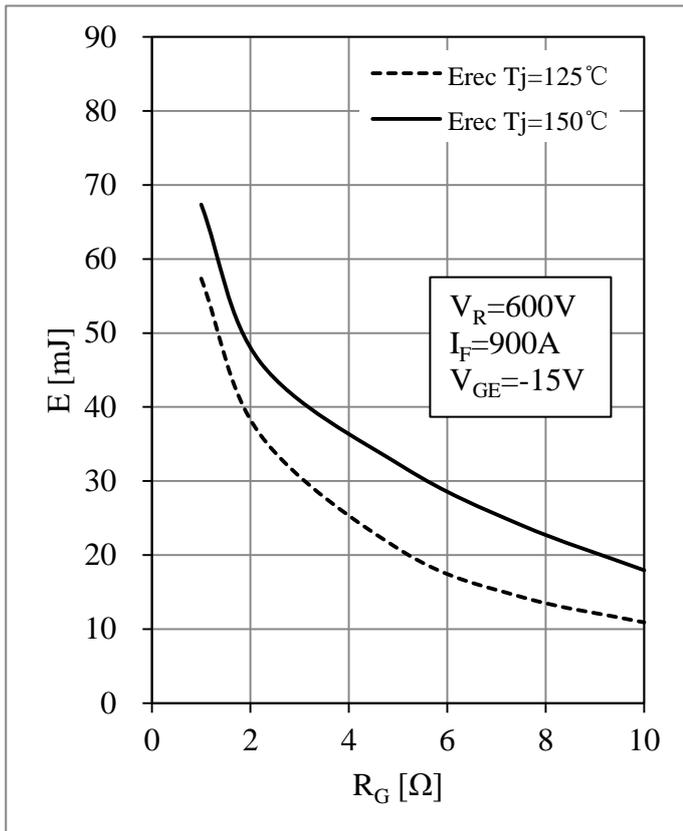


Fig 9. Diode Switching Loss vs. R_G

Fig 8. Diode Switching Loss vs. I_F

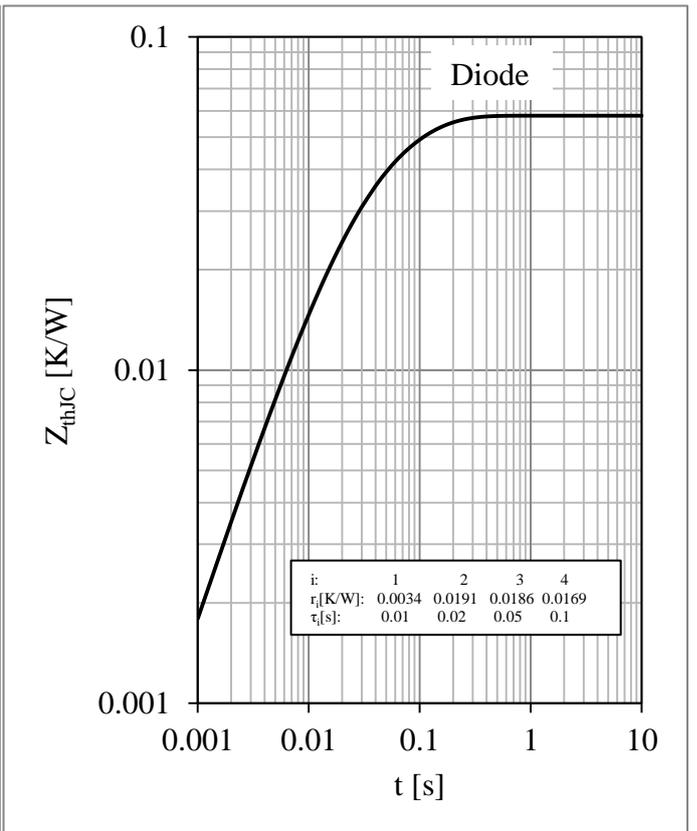
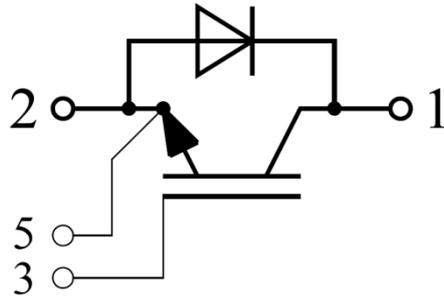


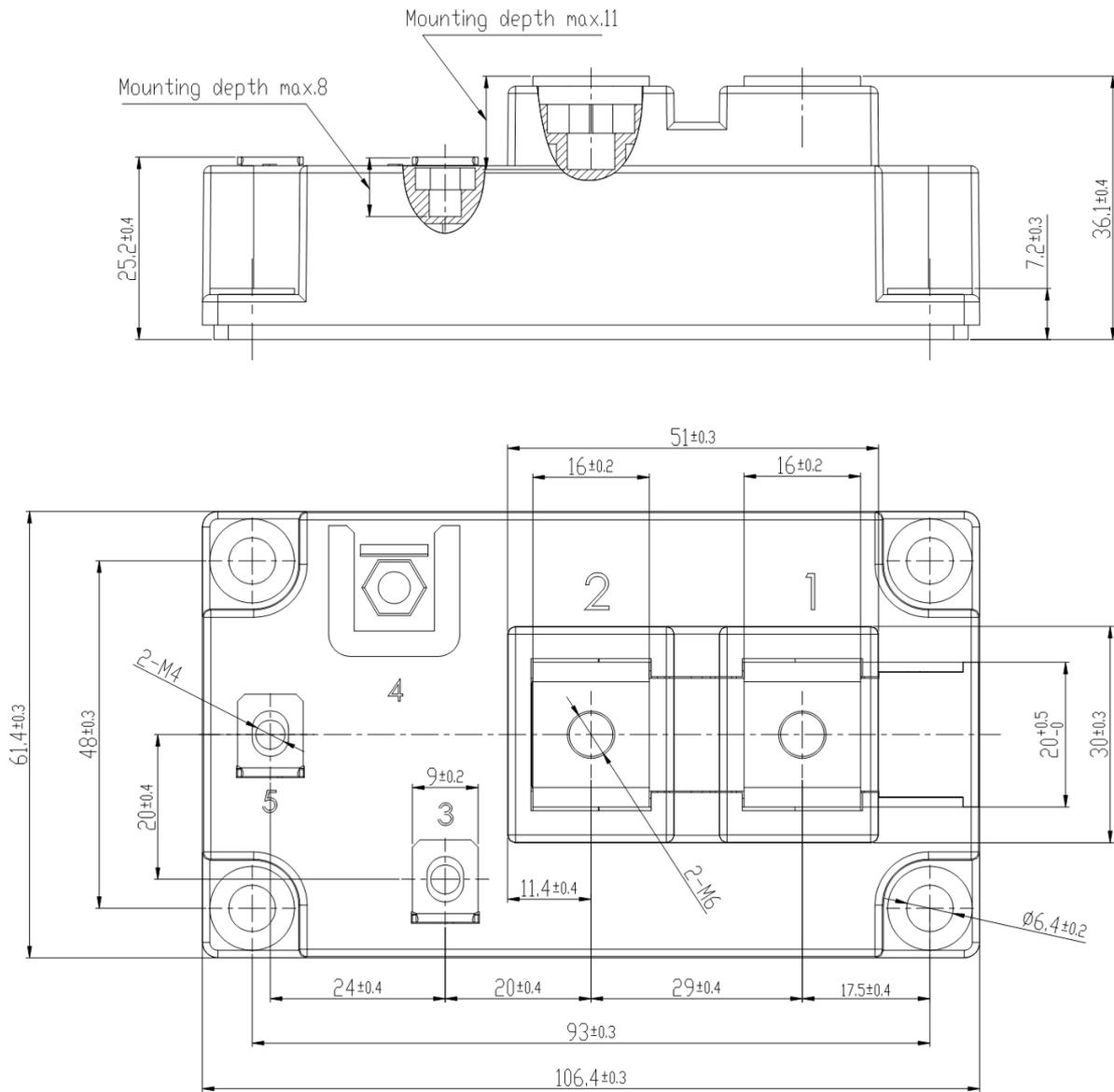
Fig 10. Diode Transient Thermal Impedance

Circuit Schematic



Package Dimensions

Dimensions in Millimeters



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